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From Ballistic Transport to Tunneling in Electromigrated Ferromagnetic Breakjunctions

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ABSTRACT

We fabricate ferromagnetic nanowires with constrictions whose cross section can be reduced gradually from 100 × 30 nm² to the atomic scale and eventually to the tunneling regime by means of electromigration. The contacts are mechanically and thermally stable. We measure low-temperature magnetoresistances (MR) < 3% for contacts < 400 Å, reproducible MR variations that are nonmonotonic in the regime 400 Å − 25 kÅ, and a maximum MR of 80% for atomic-scale widths. These results for devices > 400 Å differ from previous room-temperature studies of electrodeposited devices. For samples in the tunneling regime, we observe large fluctuations in MR, between −10 and 85%.

The entry of a magnetic domain wall into a nanometer-scale magnetic contact can cause magnetoresistance (MR = [R(AP) − R(P)]/R(P), where R(AP) is the resistance with an antiparallel orientation for the magnetizations in the electrodes and R(P) is the resistance with parallel magnetizations). Several different interesting mechanisms can contribute, depending on the size of the contact. If the device diameter is greater than tens of nanometers, then the largest contribution to the domain wall resistance is generally the anisotropic MR, a difference in the resistivity of a magnetic material depending on whether the magnetic moment is oriented parallel or perpendicular to the current. This contribution is relatively small, typically giving maximum MR values of a few percent.¹ As the contact diameter is reduced, the width of the domain wall can be constrained by the geometry and decreases in proportion to the contact width.² Eventually a new mechanism of MR may become dominant if a domain wall is sufficiently narrow that the spin of a conduction electron cannot follow the direction of the local magnetization adiabatically.³ In that case, the domain wall can produce increased electron scattering that is analogous to the giant magnetoresistance effect in magnetic multilayers.⁴ For very small metallic contacts, approaching the single-atom diameter regime, room-temperature values of MR as large as 200% to 100 000% have been reported⁵−⁷ and ascribed to a “ballistic magnetoresistance” effect involving scattering of electrons from an atomically abrupt domain wall. However, these large effects have not been reproducible in other device geometries,⁸−¹¹ and there is now considerable evidence that magnetostriction and magnetostatic forces can produce artifacts in similar experiments by causing the physical structure of the contact to change as the magnetic field is varied.⁹¹² Finally, if the contact diameter is reduced beyond the single-atom limit, then it enters the tunneling regime. MR in that regime reflects the spin polarization of tunneling electrons, and for a nanoscale device it is interesting to ask to what extent the MR depends on the atomic-scale geometry of the contacts, rather than simply the spin polarization of the bulk electron density of states.¹³¹⁴

To avoid artifacts of mechanical instabilities and achieve reliable measurements of the intrinsic magnetoresistance of atomic-scale magnetic contacts, we argue that at least three conditions should be met: (i) the magnetic electrodes should be attached rigidly to a nonmagnetic substrate with no suspended parts so that influences of magnetostriction and magnetostatic forces are minimized, (ii) the measurements should be performed at cryogenic temperatures so that the contact region is thermally stable (even at a fixed magnetic field, room temperature contacts are typically unstable on time scales of seconds¹⁰), and (iii) the geometry of the magnetic electrodes should be designed so that their moments can be controlled between reliably antiparallel and parallel configurations. Although refs ¹¹ and ¹⁵ fulfilled these conditions for larger devices, the experiments we report here are the first to fulfill all three conditions for contact sizes down to the atomic scale. We fabricate samples in which two thin-film ferromagnets are connected by a small magnetic constriction that can be controllably narrowed by electromigration from about 100 × 30 nm² to the atomic scale and finally to a tunnel junction. This allows us to study the low-temperature MR as the contact region between the...
two ferromagnets is progressively narrowed in a single sample. Our results for MR versus contact size are consistent with previous experiments for large contacts (<200 Ω), but we observe previously unreported systematic changes in a regime of intermediate resistance (400 Ω − 25 kΩ) and also the tunneling regime (>25 kΩ) that can be compared quantitatively to theoretical predictions. Our results differ significantly from previous experiments that were conducted at room temperature or that employed device geometries that were not optimal in that an accurate antiparallel (AP) alignment across the tunneling gap in an applied magnetic field of \( H = 66 \) mT.

Our device design builds on the approach taken by Pasupathy et al., in which the angle between the moments in the two magnetic electrodes could be manipulated by fabricating them with different shapes so that they undergo magnetic reversal at different values of the applied magnetic field. However, the shapes of the electrodes used in ref 16 were not optimal in that an accurate antiparallel (AP) configuration of the two moments could not be obtained reliably. In the design used here (shown in Figure 1), the electrodes are elongated along the axis perpendicular to the constriction that connects them. A magnetic field is applied parallel to the long axis of the electrodes. From simple magnetostatic considerations, one expects that dipole interactions between the two electrodes will favor AP alignment with a domain wall in the constriction region for small applied magnetic fields. For sufficiently strong applied fields, both moments align parallel (P) to the field. We have performed micromagnetic modeling of this geometry using the OOMMF code. We find that the electrodes can access some states other than the simple uniform P and AP states at intermediate values of field (see the vortex states in Figure 1B), but the local magnetizations on opposite sides of the constriction region still accurately remain either P or AP. When the electrode magnetizations are AP and they are connected by a narrow bridge of ferromagnetic metal, a domain wall forms inside the bridge. We expect that the rotation of the magnetization within the domain wall occurs in plane of the thin-film electrodes because the demagnetization field of the film will prevent the formation of a Bloch wall. However, the detailed structure of the domain wall is expected to depend on the atomic arrangement in the bridge connecting the two ferromagnets.

We fabricate the devices on top of an oxidized aluminum gate electrode (not used in this experiment), on a silicon substrate by using aligned steps of electron-beam lithography and thermal evaporation to first deposit gold contact pads 20-nm-thick and then the magnetic permalloy electrodes 30-nm-thick, with a 100-nm-wide permalloy bridge connecting the magnetic electrodes (Figure 1A). We chose permalloy for its low crystalline anisotropy, low magnetostriction, and high spin polarization at the Fermi level. To vary the size of the bridge connecting the two magnetic electrodes, we use controlled electromigration at liquid helium temperatures. We slowly ramp the voltage across the constriction while monitoring the current. At roughly 3 mA (10⁸ A/cm²), electromigration begins (as indicated by an increase in differential resistance), at which point the acquisition software quickly lowers the bias. Repeating this procedure allows us to increase the resistance of the junction to any desired value between 100 Ω and 1 kΩ with better than 10% accuracy and to values between 1 kΩ and 20 kΩ with better than 50% accuracy. Once electromigration is completed, the junctions are mechanically stable as long as they remain at low temperature, as indicated by resistances that remain unchanged within measurement accuracy on the time scale of days.

We have imaged the process of controlled electromigration inside a scanning electron microscope using test samples at room temperature. Figure 2A−C shows the gradual narrowing of the constriction as electromigration proceeds, and demonstrates that electromigration produces a single break near the narrow region of the permalloy bridge. Once the permalloy constriction becomes narrower than about 10 nm, its structure cannot be resolved in the SEM. Devices for which electromigration is allowed to proceed to form a tunneling gap exhibit magnetic tunnel-junction characteristics...
The constriction varies from 100 nm² (10⁻⁴ cm²) to approximately 1 nm² (400 Ω), and tunneling (≥ 25 kΩ), so we will analyze these regimes separately below.

When the resistance of a device is low (<400 Ω), it increases smoothly as electromigration proceeds. The cross-section of the constriction varies from 100 × 30 nm² (60 Ω) to approximately 1 nm² (400 Ω), with the latter estimate based on the Sharvin formula. In this regime we find small (<3%) positive MR, which increases as the constriction is narrowed (Figure 3A). This is consistent with other recent experiments and described well by the semiclassical theory of Levy and Zhang.¹ In this theory, the resistance of the domain wall scales inversely with its width and the MR typically ranges from 0.7% to 3% for bulk ferromagnets.

The resistance range from 400 Ω to 25 kΩ corresponds to a crossover between ballistic transport through a few atoms and tunneling. This is possible smoothly as electromigration proceeds. The cross-section of the constriction varies from 100 × 30 nm² (60 Ω) to approximately 1 nm² (400 Ω), with the latter estimate based on the Sharvin formula. In this regime we find small (<3%) positive MR, which increases as the constriction is narrowed (Figure 3A). This is consistent with other recent experiments and described well by the semiclassical theory of Levy and Zhang. In this theory, the resistance of the domain wall scales inversely with its width and the MR typically ranges from 0.7% to 3% for bulk ferromagnets.

The MR curves for all of the samples in the metallic regimes, with resistances below ℏe²/2, do not exhibit abrupt transitions between the P and AP resistances when the magnetic field is swept but rather show more gradual behavior (Figure 3B, inset). The form of the MR curve also varies as a device’s resistance is increased. This suggests that the position and structure of the domain wall in the constriction may change as the magnetic field is varied.

When the resistance of a device becomes greater than tens of kiloohms, the transport is dominated by electron tunneling. In this regime, most devices exhibit a clean switching behavior with well-defined P and AP states (Figure 2, inset). Even after the metal bridge is broken, the size of the tunneling gap can still be adjusted by further electromigration. The shape of the MR curve and the values of the switching fields do not change significantly as electromigration changes the tunnel gap, but the value of the MR and even its sign can fluctuate over a wide range (Figure 4). This suggests that the MR is sensitive to the details of the atomic structure near the tunnel gap. The tunneling current is flowing through just a few atoms on each of the electrodes, and the electronic structure at these atoms does not necessarily reflect the same degree of spin polarization as in the bulk of the ferromagnet. The histogram of MR values we measure over 38 values of resistance in 20 tunneling devices is shown in the inset of Figure 4. The MR values range from −10% to a maximum of 85%.

It is interesting to examine the bias voltage (V) dependence of the conductance and the MR. In the low resistance regime (Figure 2, inset), with stable switching between well-defined P and AP states. Conductance versus voltage measurements in the tunneling regime at 4.2 K (discussed below) show no Coulomb-blockade or Kondo behavior, demonstrating that electron transport occurs via simple tunnel junctions rather than any electromigration-formed nanoparticles.
ferromagnetic junctions with tunable cross section, with sizes ranging from $100 \times 30$ nm$^2$ to near the atomic scale. Further electromigration opens a tunneling gap between the electrodes. These devices do not have any suspended parts and are stable against magnetostriction, magnetostatic, and thermal effects. We measure the low-temperature magnetoresistance as a function of the cross-section of the constriction. When the cross-section is larger than approximately 1 nm$^2$ (corresponding to a resistance of $\sim 400 \, \Omega$) the MR is less than 3% and increases as the cross-section decreases, similar to the results of previous studies. As the contact diameter is decreased further, we observe first a minimum in the MR and sometimes a change in sign to small negative values, and then a strongly increasing positive MR as the contact approaches the atomic scale ($\sim 25 \, \Omega$). For near-atomic-sized constrictions, we observe MR as high as 80%, but find no devices in which the MR is as large as that reported previously for the ballistic magnetoresistance mechanism.$^5$-$^7$ In the tunneling regime, the MR values fluctuate over a wide range, $-10\%$ to $85\%$, even for small changes in the atomic structure near the constriction in a single device.

We note that Keane, Lu, and Natelson have posted independent results of a similar experiment recently.$^27$

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References

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